

DESCRIPTION

The SPN7002 is the N-Channel enhancement mode field effect transistors are produced using high cell density DMOS technology. These products have been designed to minimize on-state resistance while provide rugged, reliable, and fast switching performance. They can be used in most applications requiring up to 300mA DC and can deliver pulsed currents up to 1.0A. These products are particularly suited for low voltage, low current applications such as small servo motor control, power MOSFET gate drivers, and other switching applications.

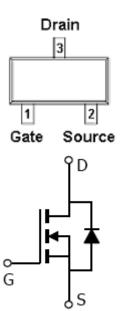
APPLICATIONS

- Drivers: Relays, Solenoids, Lamps, Hammers, Display, Memories, Transistors, etc.
- High saturation current capability. Direct Logic-Level Interface: TTL/CMOS
- Battery Operated Systems
- Solid-State Relays

FEATURES

- \bullet 60V/0.50A, RDS(ON)= 6.0 Ω @VGS=10V
- \bullet 60V/0.30A, RDS(ON)= 7.0 Ω @VGS=5V
- ◆ Super high density cell design for extremely low RDS (ON)
- Exceptional on-resistance and maximum DC current capability
- SOT-23 and SOT-323 package design

PIN CONFIGURATION(SOT-23, SOT-323)



PART MARKING



Y : Year Code W : Week Code

PIN DESCRIPTION

Pin	Symbol	Description
1	G	Gate
2	S	Source
3	D	Drain

ORDERING INFORMATION

Part Number	Package	Part Marking
SPN7002S23RG	SOT-23	S72YW
SPN7002S23RGB	SOT-23	S72YW
SPN7002S32RG	SOT-323	S72YW
SPN7002S32RGB	SOT-323	S72YW

- % Week Code : A ~ Z(1 ~ 26); a ~ z(27 ~ 52)
- **※** SPN7002S23RG : Tape Reel ; Pb − Free
- ※ SPN7002S23RGB: Tape Reel; Pb − Free; Halogen − Free
- ★ SPN7002S32RG: Tape Reel; Pb Free
- ※ SPN7002S32RGB: Tape Reel; Pb − Free; Halogen − Free

ABSOULTE MAXIMUM RATINGS (TA=25°C Unless otherwise noted)

Parameter	Symbol	Typical	Unit	
Drain-Source Voltage		Vdss	60	V
Gate –Source Voltage - Continuous		VGSS	±20	V
Gate –Source Voltage - Non Repetitive (tp < 5	VGSS	±40	V	
Continuous Drain Current(TJ=150°C)	TA=25°C	ID	0.5	A
Pulsed Drain Current (*)	IDM	1.0	A	
Power Dissipation	TA=25°C	PD	0.35	W
Operating Junction Temperature	Tı	- 55 ∼ 150	$^{\circ}\!\mathbb{C}$	
Storage Temperature Range		Tstg	- 55 ∼ 150	$^{\circ}\! \mathbb{C}$
Thermal Resistance-Junction to Ambient		R _θ JA	375	°C/W

(*) Pulse width limited by safe operating area

ELECTRICAL CHARACTERISTICS (TA=25°C Unless otherwise noted)

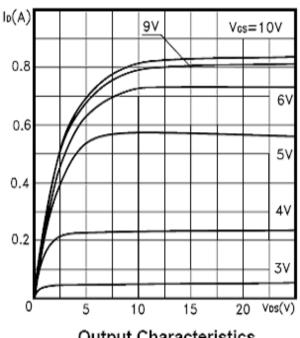
Parameter	Symbol	Conditions	Min.	Тур	Max.	Unit	
Static	<u>I</u>	1	ı		l	1	
Drain-Source Breakdown Voltage	V(BR)DSS	V _G S=0V,I _D =250uA	60			V	
Gate Threshold Voltage	VGS(th)	VDS=VGS,ID=250uA	1.0	1.7	2.5] V	
Gate Leakage Current	Igss	VDS=0V,VGS=±20V			±100	nA	
-		V _{DS} =48V,V _{GS} =0V			1		
Zero Gate Voltage Drain Current	IDSS	V _{DS} =48V,V _{GS} =0V T _J =55°C			10	uA	
Drain-Source On-Resistance	RDS(on)	Vgs=10V,Id=0.50A		2.5	6.0	Ω	
	` ′	V _{GS} = 5V,I _D =0.30A		3.3	7.0		
Source-drain Current	ISD				0.35	A	
Source-drain Current (pulsed)	ISDM (2)				1.4	A	
Forward Transconductance	Gfs(1)	$V_{DS} = 10 \text{ V}, I_{D} = 0.5 \text{ A}$		0.6		S	
Diode Forward Voltage	VsD(1)	$V_{GS} = 0 \text{ V, Is} = 0.12 \text{A}$		0.85	1.5	V	
Dynamic							
Total Gate Charge	Qg			1.4	2.0	nC	
Gate-Source Charge	Qgs	$V_{DD} = 30 \text{ V}, I_{D} = 1 \text{ A},$ $V_{GS} = 5 \text{ V}$		0.8			
Gate-Drain Charge	Qgd	- V GS - 3 V		0.5			
Input Capacitance	Ciss			43	60	pF	
Output Capacitance	Coss	$V_{DS} = 25 \text{ V, } f = 1 \text{ MHz,}$ $V_{GS} = 0$		20	30		
Reverse Transfer Capacitance	Crss	- V GS — V		6	10		
T. O. T.	td(on)			5	20		
Turn-On Time	t r	$V_{DD} = 30 \text{ V}, I_{D} = 0.5 \text{ A}$		15		ns	
	td(off)	$R_G = 4.7\Omega \text{ V}_{GS} = 4.5 \text{ V}$		7	20		
Turn-Off Time	tf			8		1	

⁽¹⁾ Pulsed: Pulse duration = 300 μ s, duty cycle 1.5 %.

⁽²⁾ Pulse width limited by safe operating area.



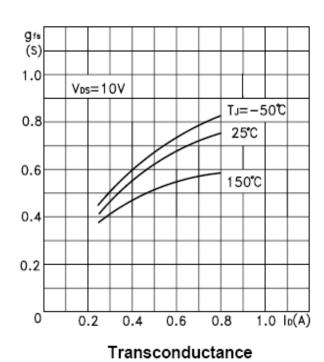
TYPICAL CHARACTERISTICS

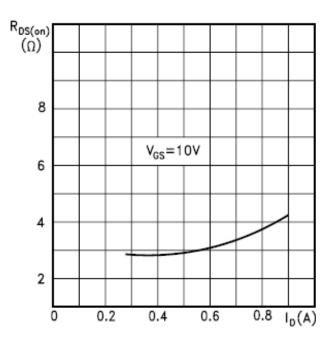


lo(A) Vos=25V 1.6 1.2 0.8 0.4

Output Characteristics



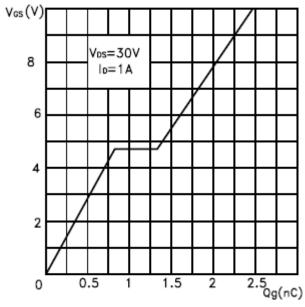




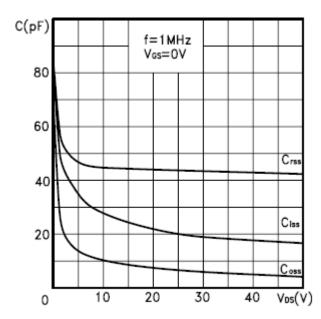
Static Drain-source On Resistance



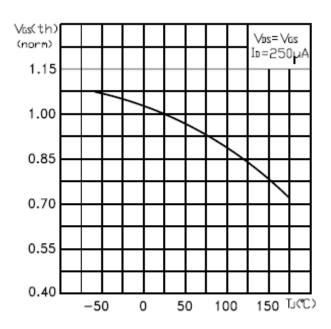
TYPICAL CHARACTERISTICS



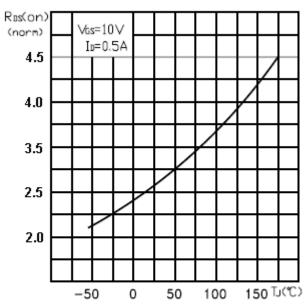
Gate Charge vs Gate-source Voltage



Capacitance Variations



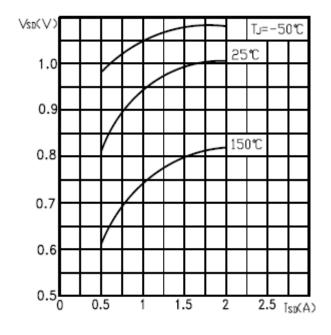
Normalized Gate Threshold Voltage vs Temperature



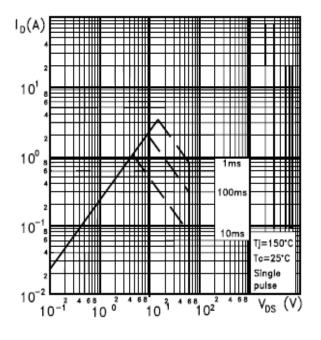
Normalized On Resistance vs Temperature



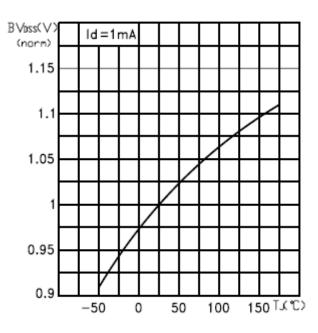
TYPICAL CHARACTERISTICS



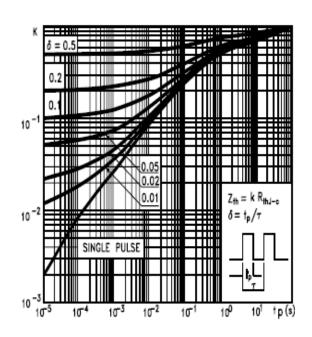
Source-Drain Forward



Safe Operating Area



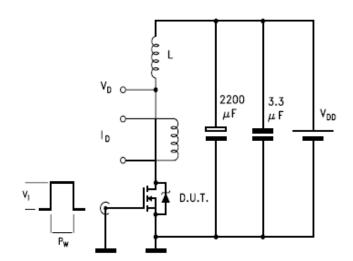
Normalized BVDSS vs Temperature



Thermal Impedance

2013/11/12 **Ver.4**

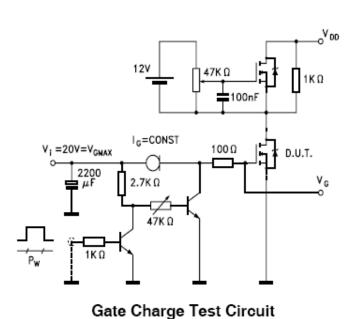
TYPICAL TESTING CIRCUIT

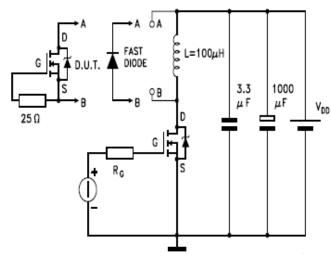


R_L 2200 3.3 μF V_{DD} V_{DD} P_W D.U.T.

Unclamped Inductive Load Test

Switching Times Test Circuit





Test Circuit For Inductive Load Switching and Diode Recovery Times

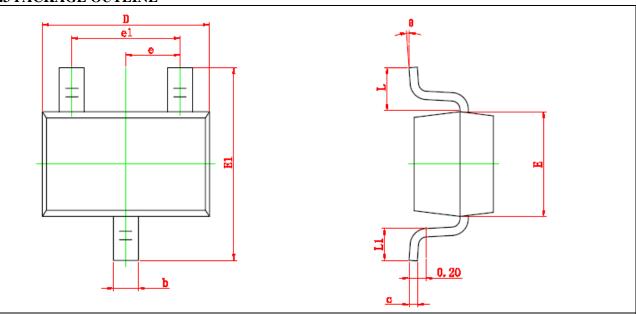


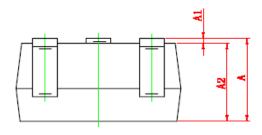
SOT-23 PACKAGE OUTLINE D 0.2

Symbol	Dimensions	In Millimeters	Dimensions In Inches	
	Min	Max	Min	Max
Α	0.900	1.200	0.035	0.043
A1	0.000	0.100	0.000	0.004
A2	0.900	1.100	0.035	0.039
b	0.300	0.500	0.012	0.020
С	0.080	0.150	0.003	0.006
D	2.800	3.000	0.110	0.118
E	1.200	1.400	0.047	0.055
E1	2.250	2.550	0.089	0.100
е	0.950 TYP		0.037	7 TYP
e1	1.800	2.000	0.071	0.079
L	0.550 REF		0.022	REF
L1	0.300	0.500	0.012	0.020
θ	0°	8°	0°	6°



SOT-323 PACKAGE OUTLINE





Symbol	Dimensions	In Millimeters	Dimensions In Inches		
	Min	Max	Min	Max	
Α	0.900	1.100	0.035	0.043	
A1	0.000	0.100	0.000	0.004	
A2	0.900	1.000	0.035	0.039	
b	0.200	0.400	0.008	0.016	
С	0.080	0.150	0.003	0.006	
D	2.000	2.200	0.079	0.087	
E	1.150	1.350	0.045	0.053	
E1	2.150	2.450	0.085	0.096	
е	0.650) TYP	0.026	TYP	
e1	1.200	1.400	0.047	0.055	
L	0.525 REF		0.021	REF	
L1	0.260	0.460	0.010	0.018	
θ	0°	8°	0°	8°	

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